

A Lower-Power Pass Transistor Based Multiband Flexible Divider with Integrated P & S Counter

Saima Mohammed Ali, Jobi Jose

Abstract—A lower-power single-phase clock multiband flexible divider with integrated P&S counter is presented. In order to enhance the working frequency of the counter, a modified form of extended true-single-phase-clock (E-TSPC) based divide-by-2/3 counter, which requires only one transistor to implement both the counting logic and the mode selection control, is used in the project. Here the gate count is reduced to a lower level by replacing the separate P –counter and S –counter used in the previous method by a single programmable integrated PS counter. This produces a multiband flexible divider with a lower power of about 11mW and a reduced gate count of about 225 and operates in 2.4 to 5 GHz and is applicable for Zigbee/IEEE 802.15.4.

Index Terms— DFF, dual modulus prescaler, dynamic logic, E-TSPC, frequency synthesizer, high-speed digital circuits, true single-phase clock (TSPC).

1 INTRODUCTION

THE use of short range wireless communications created new protocols that define all parts of communication network including physical layer. The emerging of wireless sensor and telemetry network systems, such as ZigBee, demands for low-power low-cost wireless radio-frequency transceivers, in order to achieve long operation time. Technical requirements, e.g. phase noise and channel spacing, for short-range, low data rate wireless communication systems are much relaxed. Therefore power dissipation is the most important requirement. Frequency synthesizer is one of the most critical and power-hungry components in wireless transceiver.

The rapid evolution of the communications industry has greatly increased the demand for lower cost, lower power and wider bandwidth RF circuits operating at microwave frequencies with higher level of integration. In the previous design [1], a dynamic logic multiband flexible integer-N divider based on pulse-swallow topology is proposed which uses a low-power wideband 2/3 prescaler [10] and a wideband multimodulus 32/33/47/48.

In this paper a new method for designing a dynamic logic multiband flexible integer-N-divider has been proposed which was developed using a wideband multimodulus 32/33/47/48 prescaler with a pass transistor based low-power wideband 2/3 prescaler and an integrated P & S counter as shown in Fig. 1. Swallow counter (S-counter) which was used in design [1] has been replaced by a simple digital circuit.

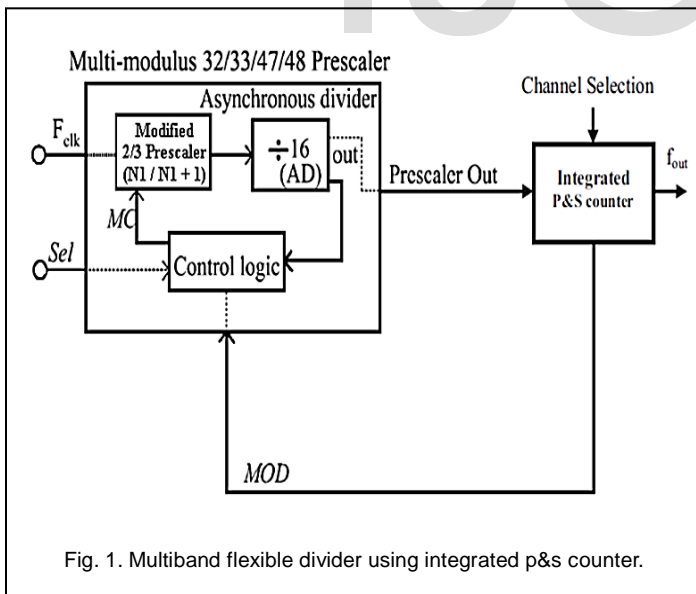


Fig. 1. Multiband flexible divider using integrated p&s counter.

2 DESIGN CONSIDERATIONS

In the case of high-speed digital circuits propagation delay and power consumption are the important parameters. The maximum operating frequency of a digital circuit is given by,

$$f_{max} = \frac{1}{tp_{LH} + tp_{HL}} \quad (1)$$

The t_{pLH} and t_{pHL} denote the propagation delays of the low-to-high and high-to-low transitions of the gates, respectively. The CMOS digital circuits total power consumption is determined by the switching and short circuit power. The switching power is linearly proportional to the operating frequency and is given by the sum of switching power at each output node as in

$$P_{switching} = \sum_{i=1}^n f_{clk} C_{Li} V_{dd}^2 \quad (2)$$

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Where n is the number of switching nodes, f_{clk} is the clock frequency, C_{Li} is the load capacitance at the output node of the i^{th} stage, and V_{dd} is the supply voltage. Normally, the short-circuit power occurs in dynamic circuits when there exists direct paths from the supply to ground which is given by

$$P_{sc} = I_{sc} * V_{dd} \tag{3}$$

Where I_{sc} is the short-circuit current. The short-circuit power is much higher in E-TSPC logic circuits than in TSPC logic circuits. However, TSPC logic circuits exhibit higher switching power compared to that of E-TSPC logic circuits due to high load capacitance. For the E-TSPC logic circuit, the short-circuit power is the major problem. The E-TSPC circuit has the merit of higher operating frequency than that of the TSPC circuit due to the reduction in load capacitance, but it consumes significantly more power than the TSPC circuit does for a given transistor size. The following analysis is based on the latest design using the popular and low-cost 0.18- μ m CMOS process.

3 DIVIDE BY 2/3 COUNTER DESIGN

The two FFs and the NOR gate are used in design [2]. The logic structure of the proposed design is shown in Fig. 2. The NOR gate is equivalent to bubbled AND gate. The NOR gate for the divide control (mode control) is replaced with a switch.

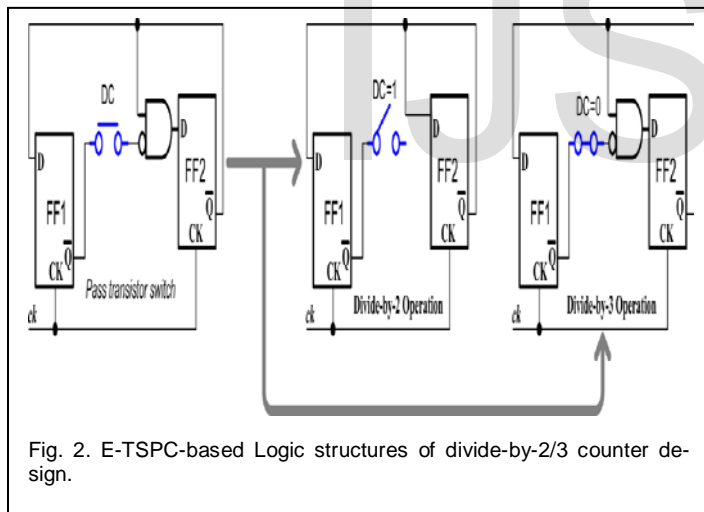


Fig. 2. E-TSPC-based Logic structures of divide-by-2/3 counter design.

Note that there is a negation bubble at one of the AND gate's input. The output of FF1 is thus complemented before being fed to FF2. When the switch is open, the input from FF1 is disconnected and FF2 alone divides the clock frequency by 2. When the switch is close, similar to the design in [7], FF1 and FF2 are linked to form a counter with three distinct states. Fig. 3 shows the circuit implementation. According to the simulation results given in [12], E-TSPC design shows the best speed performance in various counter designs including the one using conventional transmission gate FFs. Besides the speed advantage, E-TSPC FFs are particularly useful for low voltage operations because of the minimum height in transistor stacking. Other than the two E-TSPC FFs, only one pMOS transistor (P_{DC}) is needed. The PMOS transistor controlled by

the divide control signal serves as the switch. The AND gate plus its input inverter are achieved by way of wired-AND logic using no extra transistors at all. The proposed design scheme is far more sophisticated than the measure of simply adding one pass transistor may suggest. First of all, unlike any previous designs, the E-TSPC FF design remains intact without any logic embedding. Both speed and power behaviors are not affected, which indicates a performance edge over the logic embedded FF design. Secondly, the inverter to complement the one of the two E-TSPC FF outputs for divide-by-3 operations is removed in the proposed design. The circuit simplification, again, suggests the improvements in both speed and power performances. The working principle of the proposed design is elaborated as follows. When DC is "1", the pMOS transistor P_{DC} is turned off as a switch should behave. A single pMOS transistor, however, presents a smaller capacitive load to FF1 than an inverter does in design [7]. When DC is "0", the output of FF1, $Q1b$, is tied with the output node of the 1st stage inverter of FF2 through the pMOS transistor. In an E-TSPC FF design, the output of the first stage inverter can be regarded complementary to the input D, i.e., \overline{D} . Therefore, a wired-OR logic is in fact implemented. Either $Q2b$ being "0" or $Q1b$ being "1" pulls the output node of the inverter high. This means $D2b = Q1b + \overline{Q2b}$. By applying Demorgan's law to the Boolean equation gives rise to $\overline{D2b} = D2 = \overline{Q1b} \cdot \overline{Q2b}$, which is exactly the desired logic. Since $Q1b$ is applied to the input of \overline{D} , the inverter needed to complement the $Q1b$ signal can be eliminated.

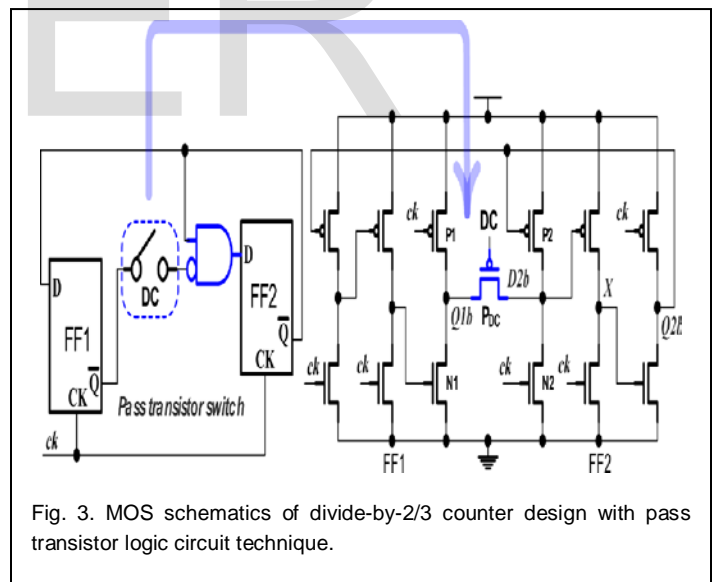


Fig. 3. MOS schematics of divide-by-2/3 counter design with pass transistor logic circuit technique.

4 MULTIMODULUS 32//33/47/48 PRESCALER

The proposed wideband multimodulus prescaler is similar to the 32/33 prescaler, but with an additional inverter and a multiplexer. The proposed prescaler can divide the input frequency by 32, 33, 47, and 48 is shown in Fig. 4. It performs additional divisions (divide-by-47 and divide-by-48) without any extra flip-flop, thus saving a considerable amount of power and also reducing the complexity of multiband divider.

The multimodulus prescaler consists of the wideband 2/3

TABLE 1
TRUTH TABLE OF XNOR GATE

Input 1	Input 2	Output
0	0	1
0	1	0
1	0	0
1	1	1

B. Case 2: Sel =1

The frequency division (FD) ratio of the multiband divider in this mode is given by:

$$FD = (N * S) + (N + 1) * (P - S) = (N + 1) P - S \tag{10}$$

Substituting P = 64, S = C in the above equation, we get:

$$FD = (N + 1) * 64 - C \tag{11}$$

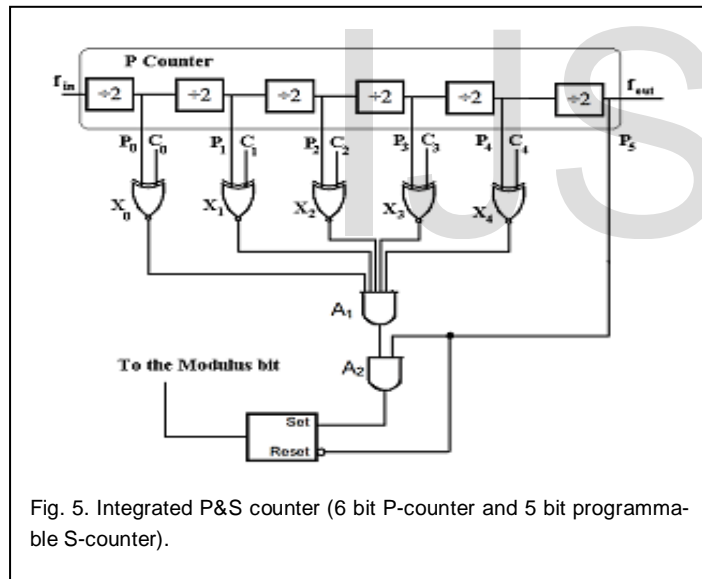


Fig. 5. Integrated P&S counter (6 bit P-counter and 5 bit programmable S-counter).

6 SIMULATION RESULTS

The simulation of the design is performed using Xilinx and Modelsim. The proposed multiband flexible divider consumes power of 11 mw and has a gate count of 225. The power consumption, gate count and area of the previous programmable dividers and the proposed programmable divider at the supply voltage of 1.8V is shown in Table II



Fig. 6. Power consumption obtained using Xilinx.

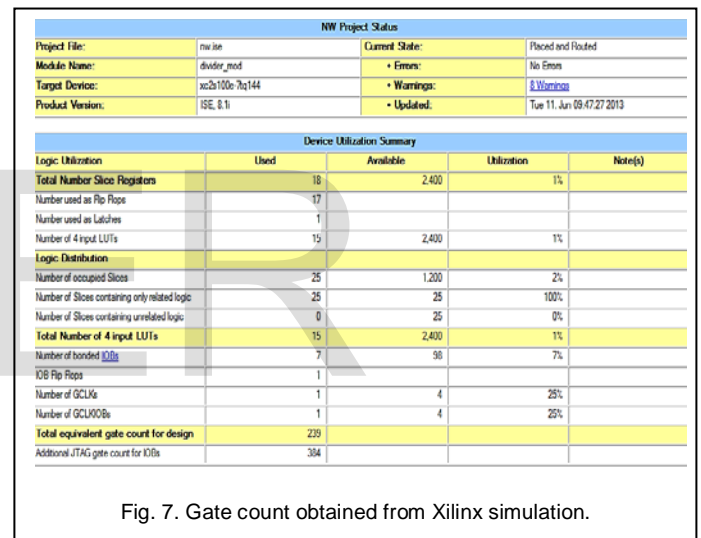


Fig. 7. Gate count obtained from Xilinx simulation.

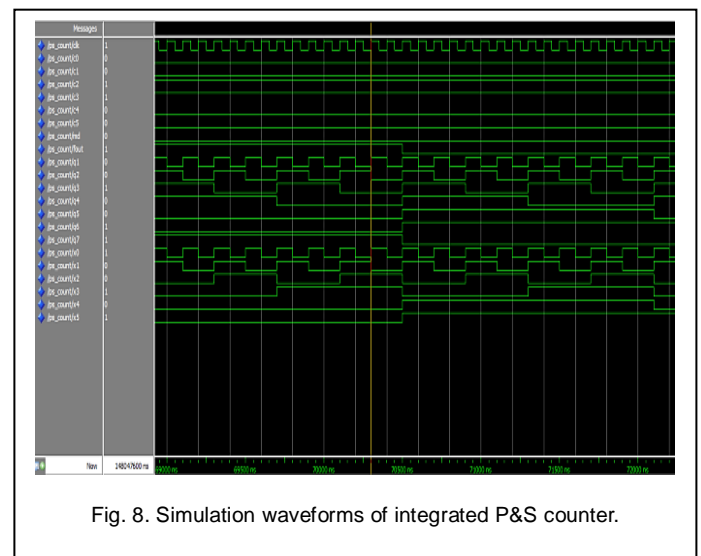


Fig. 8. Simulation waveforms of integrated P&S counter.

TABLE 2
COMPARISON OF PRESENT METHOD WITH OLD METHOD

	Old System [1]	Proposed System
Power	29 mw	11 mw
Gate Count	636	225
Area	Large	Small

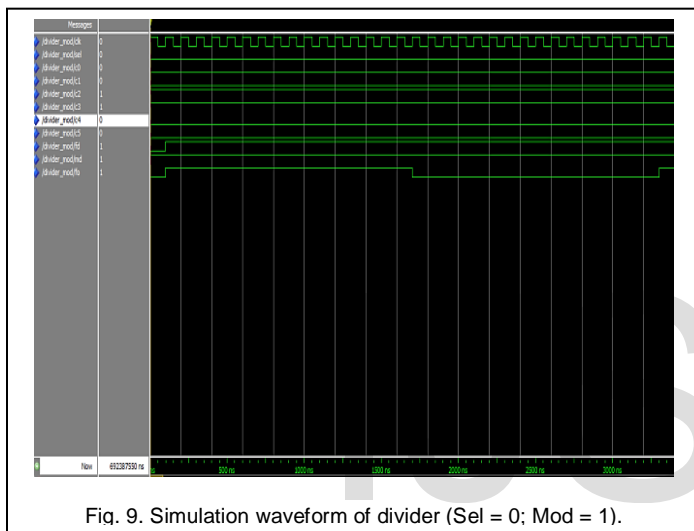


Fig. 9. Simulation waveform of divider (Sel = 0; Mod = 1).

7 CONCLUSION

In this paper a lower-power single-phase clock multiband flexible divider with integrated P&S counter is presented. The Swallow counter which consumes a large portion of energy in conventional frequency divider is replaced by a simple digital section in this structure. Also the pass transistor based divide-by-2/3 counter successfully simplifies the control logic and one pMOS transistor alone serves the purposes of both mode select and counter excitation logic. In the paper, the circuit simplicity leads to reduced power consumption, reduced number of gates required and hence a reduced area requirement.

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